

3D EM Simulator

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CST of America, Inc. announces CST MICROWAVE STUDIO® , version 2006. The new version now includes the use of the CST DESIGN ENVIRONMENT™ as a common access point to CST's solver technology. Structures are presented in 3D and schematic views and the comparison of models and co-simulation has been facilitated by a new multi-document interface. Key product features include: Easy coupling of EM with circuit and thermal analysis in one tool; automated co-simulation with Agilent Technologies' Advanced Design System; Tetrahedral frequency domain solver completed: advanced true surface meshing, absorbing boundary conditions, farfields, gyrotropic media, lumped elements, arbitrarily shaped unit cells, adaptive meshing, adaptive broadband frequency sweep; improved interface with Cadence® Allegro® and new PBA meshing algorithm, suited for highly complex imports. The CST STUDIO SUITE™ is made up of the company's 3D EM simulation tools: the CST MICROWAVE STUDIO® for high frequency applications, CST EM STUDIO™ for low frequency and statics, and CST PARTICLE STUDIO™ for charged particle dynamics, and is rounded off with CST DESIGN STUDIO™ for synthesis and circuit simulation. All programs are accessible through the CST DESIGN ENVIRONMENT™ which facilitates multiphysics and co-simulation.

CST of America, Inc.

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